

# X-Class HiPerFET™ **Power MOSFET**

# IXFK90N60X IXFX90N60X

N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Diode

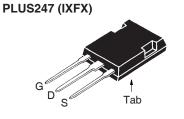


Symbol	Test Conditions	Maximum F	Ratings
V <sub>DSS</sub>	$T_J = 25^{\circ}\text{C to } 150^{\circ}\text{C}$	600	V
V <sub>DGR</sub>	$T_J = 25^{\circ}\text{C to } 150^{\circ}\text{C}, R_{GS} = 1M\Omega$	600	
V <sub>GSS</sub>	Continuous	± 30	V
V <sub>GSM</sub>	Transient	± 40	
I <sub>D25</sub>	$T_{\rm c} = 25^{\circ}{\rm C}$	90	A
	$T_{\rm c} = 25^{\circ}{\rm C}$ , Pulse Width Limited by $T_{\rm JM}$	200	A
I <sub>A</sub>	T <sub>c</sub> = 25°C	45	A
E <sub>AS</sub>	T <sub>c</sub> = 25°C	3	J
P <sub>D</sub>	T <sub>C</sub> = 25°C	1100	W
dv/dt	$I_{S} \le I_{DM}, V_{DD} \le V_{DSS}, T_{J} \le 150^{\circ}C$	50	V/ns
T <sub>J</sub> T <sub>JM</sub> T <sub>stg</sub>		-55 +150 150 -55 +150	O° O°
T <sub>L</sub>	Maximum Lead Temperature for Soldering	300	°C
T <sub>SOLD</sub>	Plastic Body for 10s	260	°C
M <sub>d</sub>	Mounting Torque (TO-264)	1.13/10	Nm/lb.in
F <sub>c</sub>	Mounting Force (PLUS247)	20120 /4.527	N/lb
Weight	TO-264	10	g
	PLUS247	6	g

Symbol (T <sub>J</sub> = 25°C U	mbol Test Conditions = 25°C Unless Otherwise Specified)		Characteristic Value Min.   Typ.   Ma		
BV <sub>DSS</sub>	$V_{GS} = 0V, I_D = 3mA$	600			V
$V_{\rm GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 8mA$	2.5		4.5	V
l <sub>gss</sub>	$V_{GS} = \pm 30V, V_{DS} = 0V$			± 100	nA
I <sub>DSS</sub>	$V_{DS} = V_{DSS}, V_{GS} = 0V$	Г <sub>Ј</sub> = 125°С		50 1.5	μA mA
R <sub>DS(on)</sub>	$V_{GS} = 10V, I_{D} = 0.5 \cdot I_{D25}, Note$	e 1		38	mΩ

600V 90A D25  $38m\Omega$  $\mathbf{R}_{\mathrm{DS(on)}}$ ≤





G	=	Gate	D	=	Drain
S	=	Source	Tab	=	Drain

#### **Features**

- International Standard Packages
- Low  $R_{\rm DS(ON)}$  and  $Q_{\rm G}$  Avalanche Rated
- Low Package Inductance

### **Advantages**

- High Power Density
- Easy to Mount
- Space Savings

## **Applications**

- Switch-Mode and Resonant-Mode **Power Supplies**
- DC-DC Converters
- PFC Circuits
- AC and DC Motor Drives
- Robotics and Servo Controls



SymbolTest ConditionsCha $(T_1 = 25^{\circ}\text{C}, \text{ Unless Otherwise Specified})$ Min.		racteristic Values		
			Typ.	Max
g <sub>fs</sub>	$V_{DS} = 10V, I_{D} = 0.5 \cdot I_{D25}, Note 1$	30	50	S
$\mathbf{R}_{Gi}$	Gate Input Resistance		1.0	Ω
C <sub>iss</sub>			8500	pF
C <sub>oss</sub>	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		6300	pF
C <sub>rss</sub>			56	pF
	Effective Output Capacitance			
$C_{o(er)}$	Energy related $\int V_{GS} = 0V$		400	pF
C <sub>o(tr)</sub>	Time related $V_{DS}^{GS} = 0.8 \cdot V_{DSS}$		1.37	nF
t <sub>d(on)</sub>	Resistive Switching Times		38	ns
t,	_		22	ns
t <sub>d(off)</sub>	$V_{GS} = 10V$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_{D} = 0.5 \cdot I_{D25}$		84	ns
t <sub>f</sub>	$R_{\rm G} = 1\Omega$ (External)		12	ns
$Q_{g(on)}$			210	nC
Q <sub>qs</sub>	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		50	nC
$Q_{gd}$			90	nC
R <sub>thJC</sub>				0.113 °C/W
R <sub>thCS</sub>			0.15	°C/W

#### Source-Drain Diode

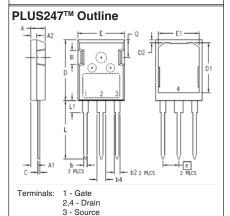
Symbo	l Test Conditions	Char	acteristi	c Values	
$(T_{J} = 25)$	5°C, Unless Otherwise Specified)	Min.	Тур.	Max.	
Is	$V_{GS} = 0V$			90	Α
I <sub>sm</sub>	Repetitive, Pulse Width Limited by $T_{_{JM}}$			360	Α
V <sub>SD</sub>	$I_F = I_S$ , $V_{GS} = 0V$ , Note 1			1.4	V
t <sub>rr</sub>	$I_{E} = 45A$ , $-di/dt = 100A/\mu s$		210		ns
$\mathbf{Q}_{_{\mathrm{RM}}}$	<b>&gt;</b> '		1.8		μC
I <sub>RM</sub>	$V_{R} = 100V, V_{GS} = 0V$		16.8		A

Note 1. Pulse test,  $t \le 300\mu s$ , duty cycle,  $d \le 2\%$ .

### PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

#### TO-264P Outline R1J D2x2e 1 = Gate 2,4 = Drain 3 = Source **MILLIMETERS INCHES** SYM MIN MAX MIN MAX 4.70 Α .209 Α1 0.90 2.30 2.80 .049 Ь1 .091 .106 b2 110 .033 1.035 .799 0.50 25.70 19.90 1.012 .783 D 1 4.70 19.70 185 .661 .215 BSC .768 .807 5.46 19.50 .091 .106 2.30 5.80 8.80 3.80 Q Q1 .228 .346 .244 .362 9.20 .150 .071 .165 .087 ØR ØR1 1.80

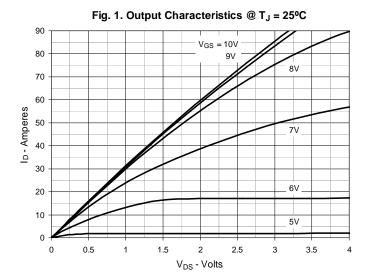


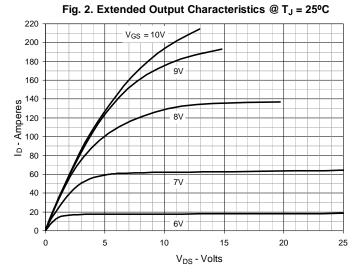
SYM	INCH	INCHES		1ETERS
SIM	MIN	MAX	MIN	MAX
Α	.190	.205	4.83	5.21
A1	.090	.100	2.29	2,54
A2	.075	.085	1.91	2.16
Ь	.045	.055	1.14	1.40
b2	.075	.087	1.91	2.20
b4	.115	.126	2.92	3.20
С	.024	.031	0.61	0.80
D	.819	.840	20.80	21.34
D1	.650	.690	16.51	17.53
D2	.035	.050	0.89	1.27
Ε	.620	.635	15.75	16.13
E1	.520	.560	13.08	14.22
е	.215	BSC	5.45 BSC	
L	.780	.810	19.81	20.57
1.4	150	470	0.04	1.00

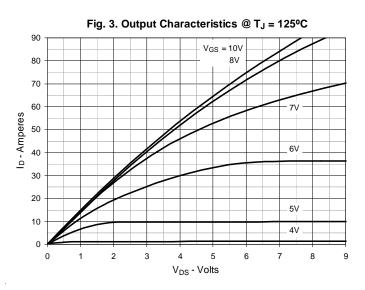
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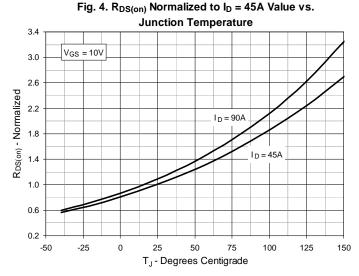
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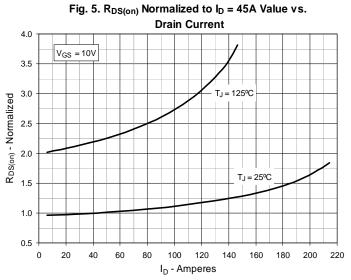


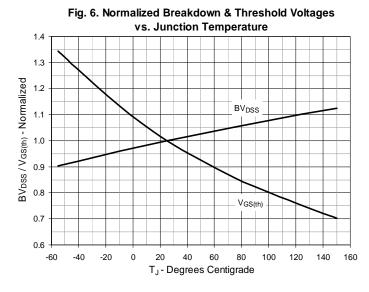




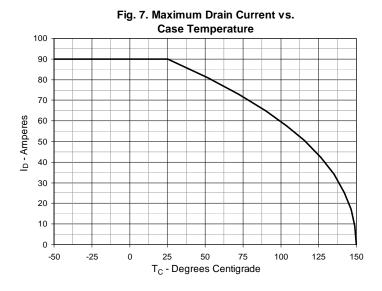


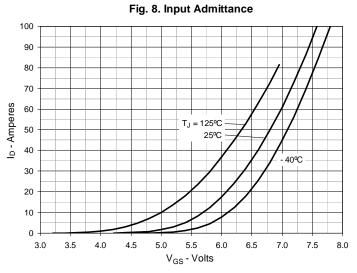


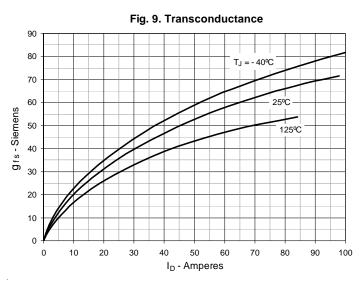


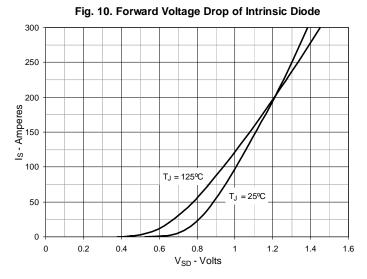


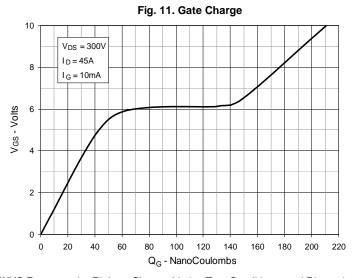


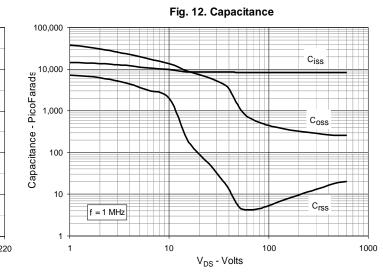




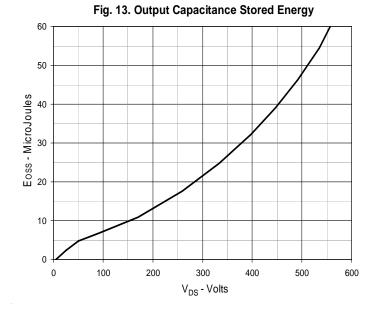








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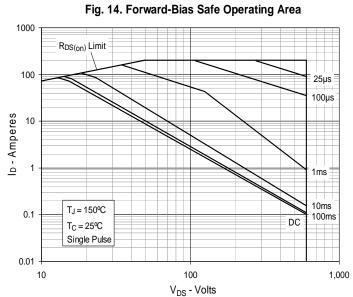


Fig. 15. Maximum Transient Thermal Impedance

